

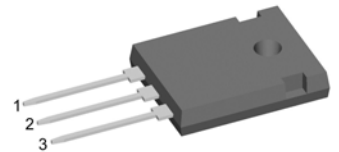
# XPT IGBT

|               |   |             |
|---------------|---|-------------|
|               |   | preliminary |
| $V_{CES}$     | = | 1200V       |
| $I_{C25}$     | = | 20A         |
| $V_{CE(sat)}$ | = | 1.8V        |

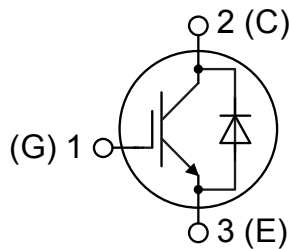
Copack

Part number

**IXA12IF1200HB**



Backside: collector



**Features / Advantages:**

- Easy paralleling due to the positive temperature coefficient of the on-state voltage
- Rugged XPT design (Xtreme light Punch Through) results in:
  - short circuit rated for 10  $\mu$ sec.
  - very low gate charge
  - low EMI
  - square RBSOA @ 3x  $I_c$
- Thin wafer technology combined with the XPT design results in a competitive low  $V_{CE(sat)}$
- SONIC™ diode
  - fast and soft reverse recovery
  - low operating forward voltage

**Applications:**

- AC motor drives
- Solar inverter
- Medical equipment
- Uninterruptible power supply
- Air-conditioning systems
- Welding equipment
- Switched-mode and resonant-mode power supplies
- Inductive heating, cookers
- Pumps, Fans

**Package: TO-247**

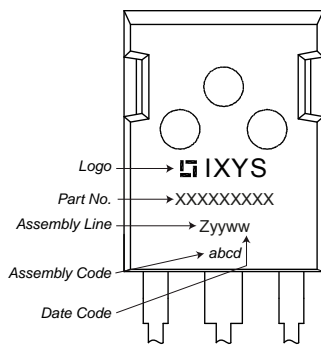
- Industry standard outline
- RoHS compliant
- Epoxy meets UL 94V-0

| IGBT          |  |  |                                | Ratings |          |               |  |
|---------------|--|--|--------------------------------|---------|----------|---------------|--|
| Symbol        | Definition                             | Conditions   | min.                           | typ.    | max.     | Unit          |  |
| $V_{CES}$     | collector emitter voltage              | $T_{VJ} = 25^{\circ}\text{C}$  |                                |         | 1200     | V             |  |
| $V_{GES}$     | max. DC gate voltage                   |  |                                |         | $\pm 20$ | V             |  |
| $V_{GEM}$     | max. transient gate emitter voltage    |  |                                |         | $\pm 30$ | V             |  |
| $I_{C25}$     | collector current                      | $T_C = 25^{\circ}\text{C}$   |                                |         | 20       | A             |  |
| $I_{C100}$    |  | $T_C = 100^{\circ}\text{C}$  |                                |         | 13       | A             |  |
| $P_{tot}$     | total power dissipation                | $T_C = 25^{\circ}\text{C}$   |                                |         | 85       | W             |  |
| $V_{CE(sat)}$ | collector emitter saturation voltage   | $I_C = 10\text{A}; V_{GE} = 15\text{V}$  |                                | 1.8     | 2.1      | V             |  |
|               |  |  |                                | 2.1     |          | V             |  |
| $V_{GE(th)}$  | gate emitter threshold voltage         | $I_C = 0.3\text{mA}; V_{GE} = V_{CE}$  | 5.4                            | 5.9     | 6.5      | V             |  |
| $I_{CES}$     | collector emitter leakage current      | $V_{CE} = V_{CES}; V_{GE} = 0\text{V}$   |                                |         | 0.1      | mA            |  |
|               |  |  |                                | 0.1     |          | mA            |  |
| $I_{GES}$     | gate emitter leakage current           | $V_{GE} = \pm 20\text{V}$  |                                |         | 500      | nA            |  |
| $Q_{G(on)}$   | total gate charge                      | $V_{CE} = 600\text{V}; V_{GE} = 15\text{V}; I_C = 10\text{A}$  |                                | 27      |          | nC            |  |
| $t_{d(on)}$   | turn-on delay time                     | inductive load<br>$V_{CE} = 600\text{V}; I_C = 10\text{A}$<br>$V_{GE} = \pm 15\text{V}; R_G = 100\Omega$ | $T_{VJ} = 125^{\circ}\text{C}$ | 70      |          | ns            |  |
| $t_r$         | current rise time                      |  |                                | 40      |          | ns            |  |
| $t_{d(off)}$  | turn-off delay time                    |  |                                | 250     |          | ns            |  |
| $t_f$         | current fall time                      |  |                                | 100     |          | ns            |  |
| $E_{on}$      | turn-on energy per pulse               |  |                                | 1.1     |          | mJ            |  |
| $E_{off}$     | turn-off energy per pulse              |  |                                | 1.1     |          | mJ            |  |
| <b>RBSOA</b>  | reverse bias safe operating area       | $V_{GE} = \pm 15\text{V}; R_G = 100\Omega$   | $T_{VJ} = 125^{\circ}\text{C}$ |         |          |               |  |
| $I_{CM}$      |  | $V_{CEmax} = 1200\text{V}$   |                                |         | 30       | A             |  |
| <b>SCSOA</b>  | short circuit safe operating area      | $V_{CEmax} = 900\text{V}$  | $T_{VJ} = 125^{\circ}\text{C}$ |         |          |               |  |
| $t_{sc}$      | short circuit duration                 | $V_{CE} = 900\text{V}; V_{GE} = \pm 15\text{V}$  |                                |         | 10       | $\mu\text{s}$ |  |
| $I_{sc}$      | short circuit current                  | $R_G = 100\Omega; \text{non-repetitive}$   |                                | 40      |          | A             |  |
| $R_{thJC}$    | thermal resistance junction to case    |  |                                |         | 1.5      | K/W           |  |
| $R_{thCH}$    | thermal resistance case to heatsink    |  |                                | 0.25    |          | K/W           |  |
| <b>Diode</b>  |  |  |                                |         |          |               |  |
| $V_{RRM}$     | max. repetitive reverse voltage        |  | $T_{VJ} = 25^{\circ}\text{C}$  |         | 1200     | V             |  |
| $I_{F25}$     | forward current                        |  | $T_C = 25^{\circ}\text{C}$     |         | 22       | A             |  |
| $I_{F100}$    |  |  | $T_C = 100^{\circ}\text{C}$    |         | 14       | A             |  |
| $V_F$         | forward voltage                        | $I_F = 10\text{A}$   | $T_{VJ} = 25^{\circ}\text{C}$  |         | 2.20     | V             |  |
|               |  |  | $T_{VJ} = 125^{\circ}\text{C}$ | 1.95    |          | V             |  |
| $I_R$         | reverse current                        | $V_R = V_{RRM}$  | $T_{VJ} = 25^{\circ}\text{C}$  |         | *        | mA            |  |
|               | * not applicable, see Ices value above |  | $T_{VJ} = 125^{\circ}\text{C}$ | *       |          | mA            |  |
| $Q_{rr}$      | reverse recovery charge                | $V_R = 600\text{V}$<br>$-di_F/dt = -250\text{A}/\mu\text{s}$<br>$I_F = 10\text{A}; V_{GE} = 0\text{V}$   | $T_{VJ} = 125^{\circ}\text{C}$ | 1.3     |          | $\mu\text{C}$ |  |
| $I_{RM}$      | max. reverse recovery current          |  |                                | 10.5    |          | A             |  |
| $t_{rr}$      | reverse recovery time                  |  |                                | 350     |          | ns            |  |
| $E_{rec}$     | reverse recovery energy                |  |                                | 0.35    |          | mJ            |  |
| $R_{thJC}$    | thermal resistance junction to case    |  |                                |         | 1.8      | K/W           |  |
| $R_{thCH}$    | thermal resistance case to heatsink    |  |                                | 0.25    |          | K/W           |  |

preliminary

| Package TO-247 |                              |              | Ratings |      |      |      |
|----------------|------------------------------|--------------|---------|------|------|------|
| Symbol         | Definition                   | Conditions   | min.    | typ. | max. | Unit |
| $I_{RMS}$      | RMS current                  | per terminal |         |      | 70   | A    |
| $T_{VJ}$       | virtual junction temperature |              | -40     |      | 150  | °C   |
| $T_{op}$       | operation temperature        |              | -40     |      | 125  | °C   |
| $T_{stg}$      | storage temperature          |              | -40     |      | 150  | °C   |
| <b>Weight</b>  |                              |              |         | 6    |      | g    |
| $M_D$          | mounting torque              |              | 0.8     |      | 1.2  | Nm   |
| $F_C$          | mounting force with clip     |              | 20      |      | 120  | N    |

### Product Marking



### Part number

- I = IGBT
- X = XPT IGBT
- A = Gen 1 / std
- 12 = Current Rating [A]
- IF = Copack
- 1200 = Reverse Voltage [V]
- HB = TO-247AD (3)

| Ordering | Part Number   | Marking on Product | Delivery Mode | Quantity | Code No. |
|----------|---------------|--------------------|---------------|----------|----------|
| Standard | IXA12IF1200HB | IXA12IF1200HB      | Tube          | 30       | 508453   |

| Similar Part  | Package              | Voltage class |
|---------------|----------------------|---------------|
| IXA12IF1200PB | TO-220AB (3)         | 1200          |
| IXA12IF1200TC | TO-268AA (D3Pak) (2) | 1200          |

### Equivalent Circuits for Simulation

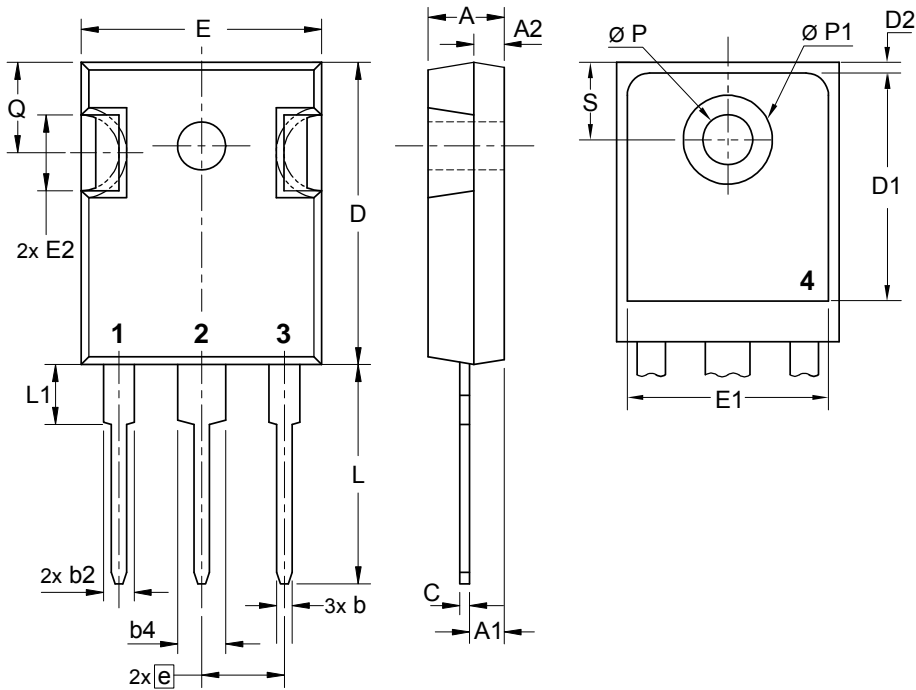
\* on die level

$T_{VJ} = 150\text{ }^{\circ}\text{C}$

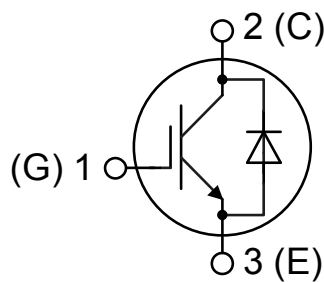


|                                | IGBT | Diode |    |
|--------------------------------|------|-------|----|
| $V_{0\max}$ threshold voltage  | 1.1  | 1.25  | V  |
| $R_{0\max}$ slope resistance * | 153  | 85    | mΩ |

## Outlines TO-247



| Sym. | Inches    |       | Millimeter |       |
|------|-----------|-------|------------|-------|
|      | min.      | max.  | min.       | max.  |
| A    | 0.185     | 0.209 | 4.70       | 5.30  |
| A1   | 0.087     | 0.102 | 2.21       | 2.59  |
| A2   | 0.059     | 0.098 | 1.50       | 2.49  |
| D    | 0.819     | 0.845 | 20.79      | 21.45 |
| E    | 0.610     | 0.640 | 15.48      | 16.24 |
| E2   | 0.170     | 0.216 | 4.31       | 5.48  |
| e    | 0.215 BSC |       | 5.46 BSC   |       |
| L    | 0.780     | 0.800 | 19.80      | 20.30 |
| L1   | -         | 0.177 | -          | 4.49  |
| Ø P  | 0.140     | 0.144 | 3.55       | 3.65  |
| Q    | 0.212     | 0.244 | 5.38       | 6.19  |
| S    | 0.242 BSC |       | 6.14 BSC   |       |
| b    | 0.039     | 0.055 | 0.99       | 1.40  |
| b2   | 0.065     | 0.094 | 1.65       | 2.39  |
| b4   | 0.102     | 0.135 | 2.59       | 3.43  |
| c    | 0.015     | 0.035 | 0.38       | 0.89  |
| D1   | 0.515     | -     | 13.07      | -     |
| D2   | 0.020     | 0.053 | 0.51       | 1.35  |
| E1   | 0.530     | -     | 13.45      | -     |
| Ø P1 | -         | 0.29  | -          | 7.39  |



## IGBT

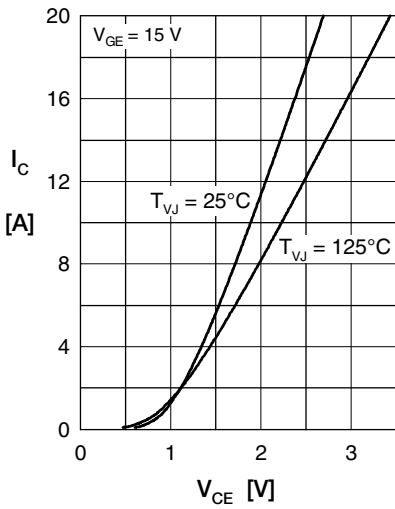


Fig. 1 Typ. output characteristics

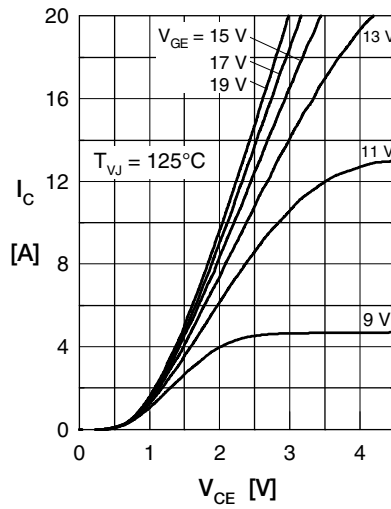


Fig. 2 Typ. output characteristics

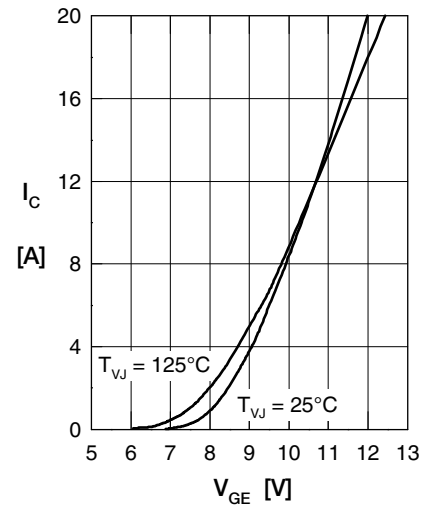


Fig. 3 Typ. transfer characteristics



Fig. 4 Typ. turn-on gate charge



Fig. 5 Typ. switching energy vs. collector current

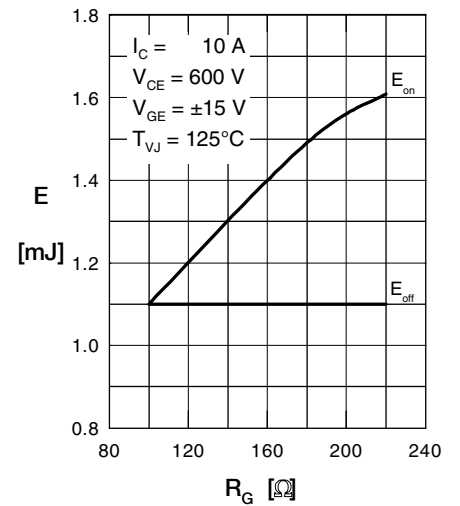


Fig. 6 Typ. switching energy vs. gate resistance

Fig. 7 Typ. transient thermal impedance junction to case

## Diode

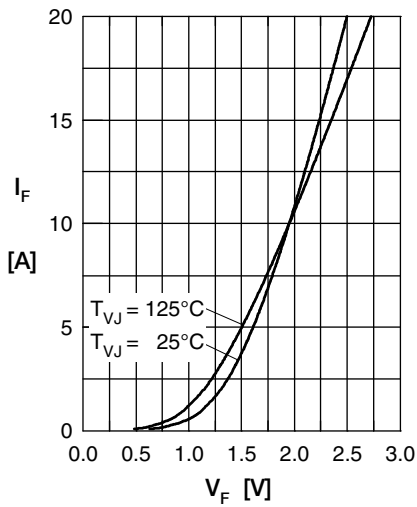


Fig. 1 Typ. forward current versus  $V_F$

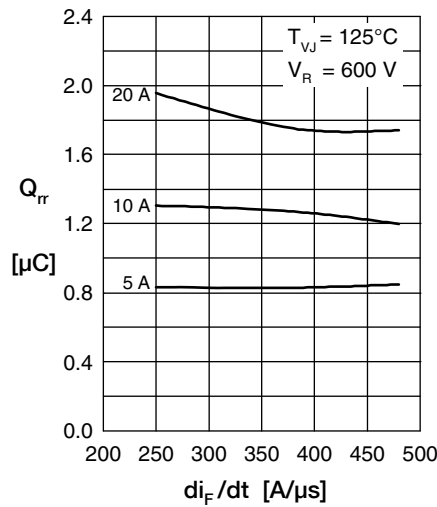


Fig. 2 Typical reverse recov. charge  $Q_{rr}$  versus  $di_F/dt$

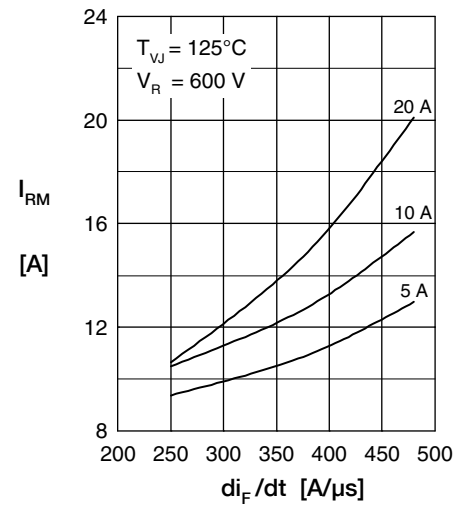


Fig. 3 Typ. peak reverse current  $I_{RM}$  versus  $di_F/dt$

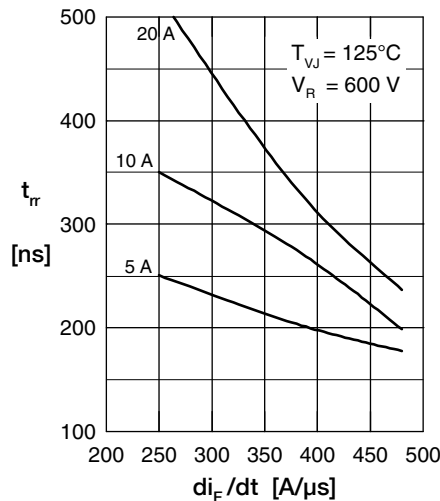


Fig. 4 Dynamic parameters  $Q_{rr}$ ,  $I_{RM}$  versus  $T_{VJ}$

Fig. 5 Typ. recovery time  $t_{rr}$  versus  $di_F/dt$

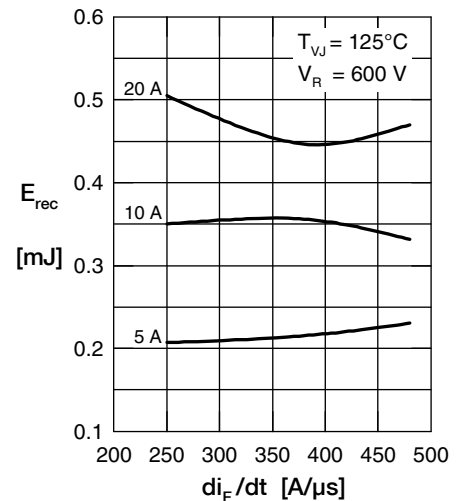


Fig. 6 Typ. recovery energy  $E_{rec}$  vs.  $di_F/dt$

Fig. 7 Typ. transient thermal impedance junction to case